

# PTNC210604MD

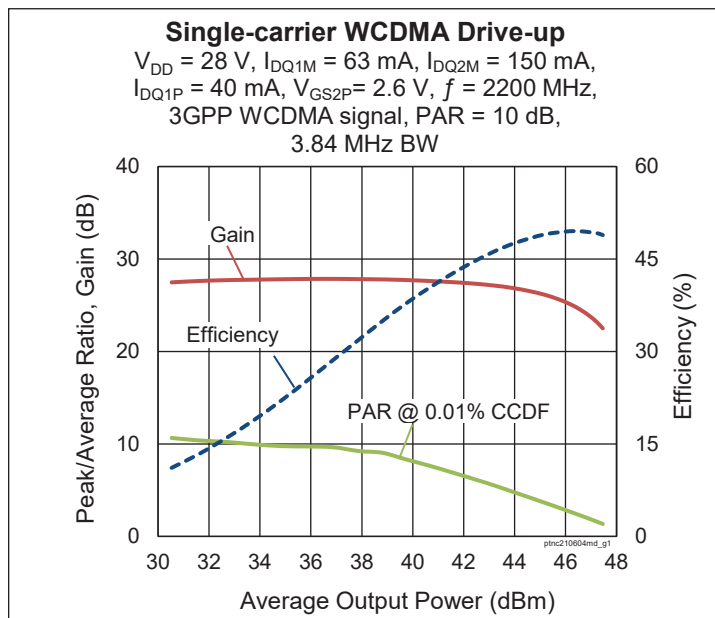
## Wideband LDMOS Two-stage Integrated Power Amplifier 20 W + 40 W, 28 V, 1805 – 2200 MHz

### Description

The PTNC210604MD is a wideband, two-stage, LDMOS integrated power amplifier. It incorporates internal matching for operation from 1805 MHz to 2200 MHz, and dual independent outputs with 20 W and 40 W of output power each. It is available in a 14-lead plastic overmold package with gull wing leads.



PTNC210604MD  
Package PG-HB1DSO-14-1



### Features

- On-chip matching for broadband operation
- Typical CW performance, 2200 MHz, 28 V, combined outputs
  - Output power at P3dB = 63 W
  - Linear Gain = 28 dB
  - Efficiency = 50.5%
- Capable of handling 10:1 VSWR @28 V, 10 W mod avg output power
- Integrated ESD protection
- Human Body Model Class 1A (per ANSI/ESDA/ JEDEC JS-001)
- Integrated temperature compensation
- Pb-free and RoHS compliant

### RF Characteristics

#### Single-carrier WCDMA Specifications (tested in Wolfspeed Doherty test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ1M} = 63\text{ mA}$ ,  $I_{DQ2M} = 150\text{ mA}$ ,  $I_{DQ1P} = 40\text{ mA}$ ,  $V_{GS2P} = 2.6\text{ V}$ ,  $P_{OUT} = 10\text{ W avg}$ ,  $f = 2200\text{ MHz}$ , 3GPP WCDMA signal, channel bandwidth = 3.84 MHz, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	26	27	—	dB
Drain Efficiency	$\eta_D$	34.5	37	—	%
Adjacent Channel Power Ratio	ACPR	—	-33	-28	dBc
Output PAR at 0.01% probability on CCDF	OPAR	7.5	8.1	—	dB

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

## DC Characteristics

Characteristics	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 51.7\ \mu\text{A}$	$V_{(BR)DSS}$	64	—	—	V
Drain Leakage Current – Stage 1	$V_{DS} = 28\text{ V}, V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	0.1	$\mu\text{A}$
	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
Drain Leakage Current – Stage 2	$V_{DS} = 28\text{ V}, V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	0.1	$\mu\text{A}$
	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
Gate Leakage Current – Stage 1	$V_{GS} = 1\text{ V}, V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	0.1	$\mu\text{A}$
Gate Leakage Current – Stage 2	$V_{GS} = 1\text{ V}, V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	0.1	$\mu\text{A}$
On-State Resistance – Stage 1 (Main)	$V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	5.8	—	$\Omega$
	(Peak) $V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	3.7	—	$\Omega$
On-State Resistance – Stage 2 (Main)	$V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.66	—	$\Omega$
	(Peak) $V_{GS} = 10\text{ V}, V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.33	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 28\text{ V}, I_{DQ1M} = 63\text{ mA}$	$V_{GS2}$	—	2.90	—	V
	$V_{DS} = 28\text{ V}, I_{DQ2M} = 150\text{ mA}$	$V_{GS2}$	—	2.76	—	V
	$V_{DS} = 28\text{ V}, I_{DQ1P} = 40\text{ mA}$	$V_{GS2}$	—	2.72	—	V
	$V_{DS} = 28\text{ V}$	$V_{GS2}$	—	2.11	—	V
Fixture Operating Gate Voltage	$V_{DS} = 28\text{ V}, I_{DQ1M} = 63\text{ mA}$	$V_{GS2}$	—	5.40	—	V
	$V_{DS} = 28\text{ V}, I_{DQ2M} = 150\text{ mA}$	$V_{GS2}$	—	4.37	—	V
	$V_{DS} = 28\text{ V}, I_{DQ1P} = 40\text{ mA}$	$V_{GS2}$	—	3.95	—	V
	$V_{DS} = 28\text{ V}$	$V_{GS2}$	—	2.60	—	V

## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-6 to +10	V
Operating Voltage	$V_{DD}$	0 to +32	V
Junction Temperature	$T_J$	225	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to +150	$^{\circ}\text{C}$

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal Resistance Stage 1 ( $T_{CASE} = 70^{\circ}C, 12 W CW$ )	$R_{\theta JC}$	4.6	$^{\circ}C/W$
Stage 2 ( $T_{CASE} = 70^{\circ}C, 12 W CW$ )	$R_{\theta JC}$	1.5	$^{\circ}C/W$

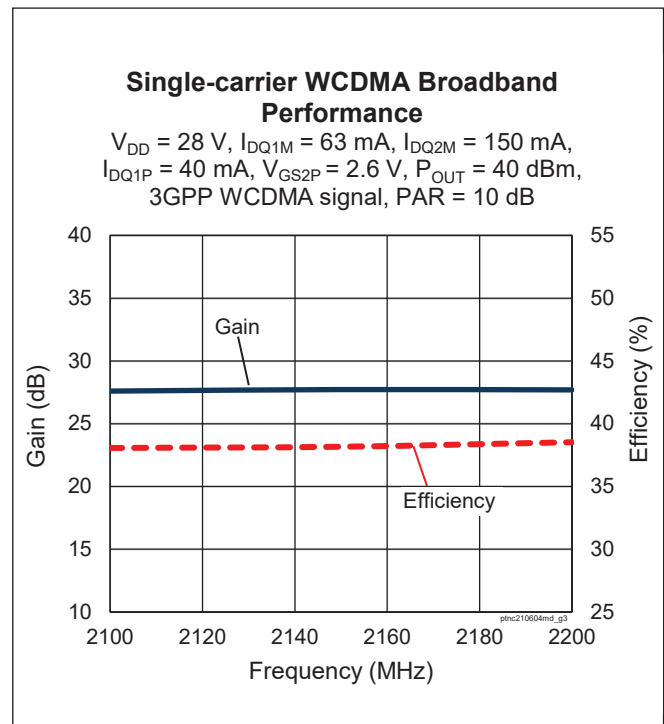
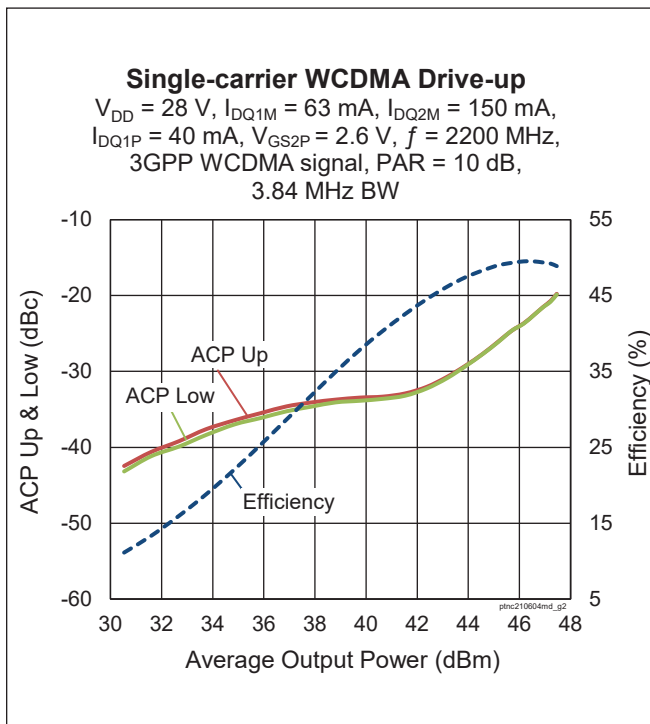
**Moisture Sensitivity Level**

Level	Test Standard	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	$^{\circ}C$

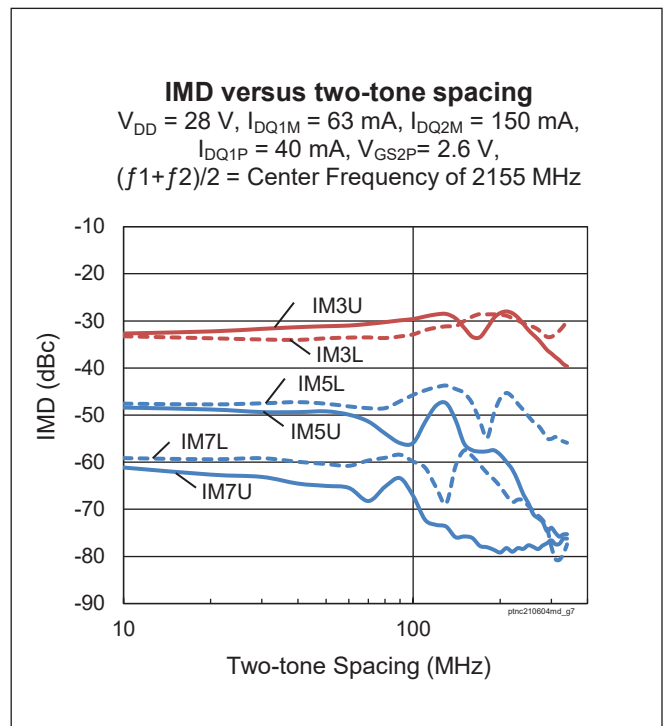
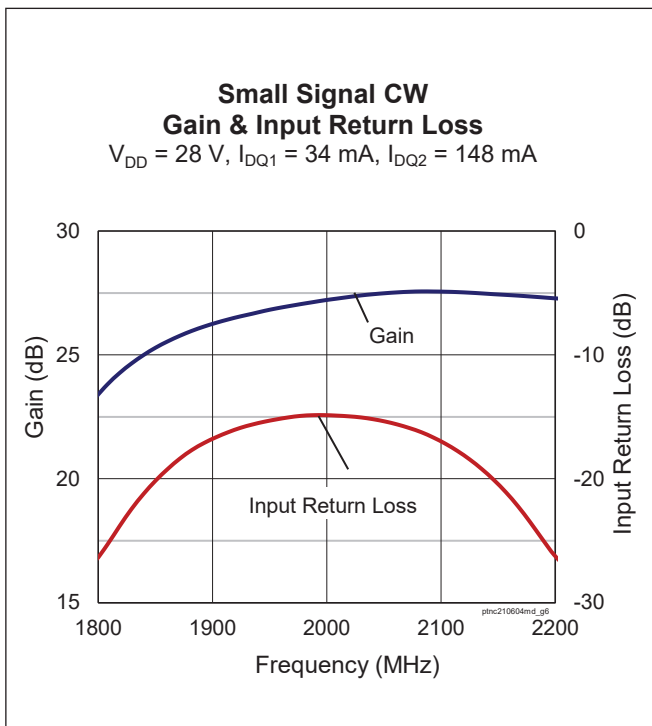
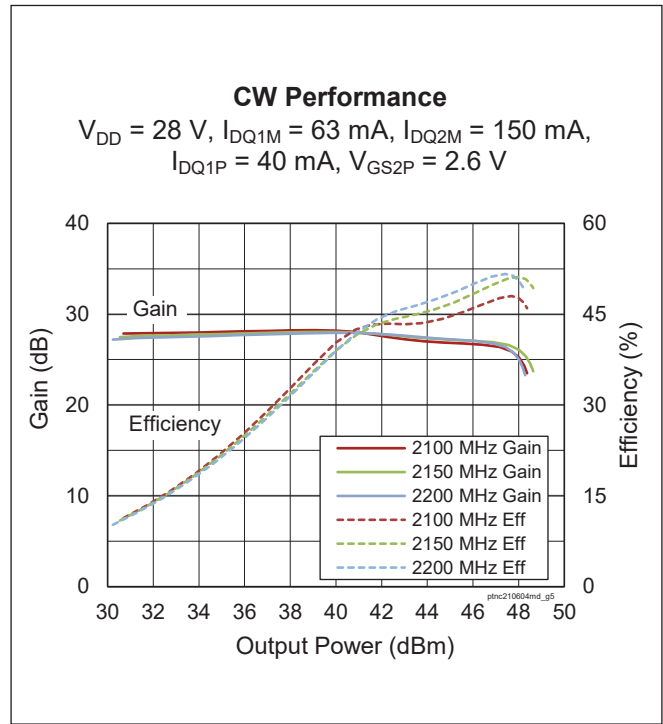
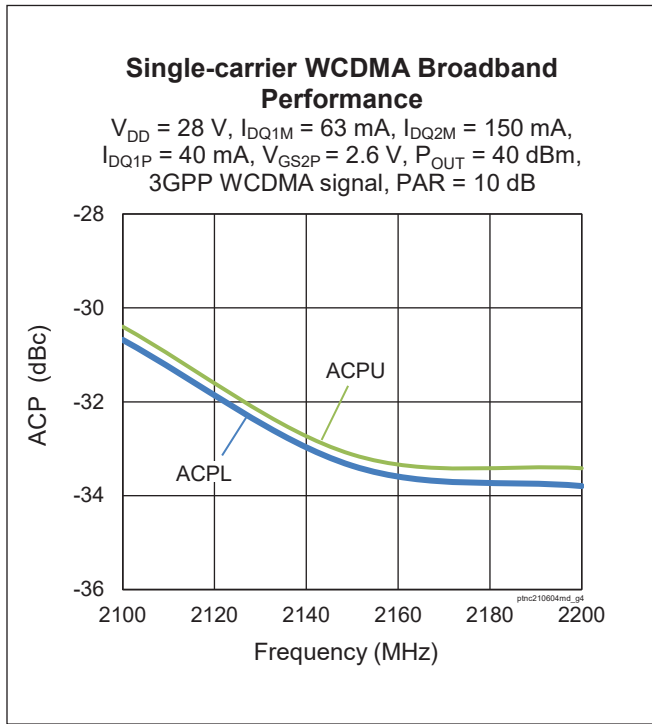
**Ordering Information**

Type and Version	Order Code	Package	Shipping
PTNC210604MD V1 R5	PTNC210604MD-V1-R5	PG-HB1DSO-14-1	Tape & Reel, 500 pcs

**Typical Performance** (data taken in test fixture, 2100 MHz to 2200 MHz)



**Typical Performance** (data taken in test fixture, 2100 MHz to 2200 MHz)



Load Pull Performance

Main Side Load Pull Performance – Pulsed CW signal: 1 ms, 10% duty cycle, 28 V, I<sub>DQ</sub> = 63 mA, 150 mA

		P <sub>1dB</sub>									
		Max Output Power					Max PAE				
Freq [MHz]	Z <sub>s</sub> [W]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>1dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>1dB</sub> [dBm]	P <sub>1dB</sub> [W]	PAE [%]
1805	50+j0.00	10.1-j12.9	31.6	43.8	24.0	51.4	22.1-j13.9	32.8	42.2	16.5	58.4
1880	50+j0.00	9.5-j11.9	31.6	43.8	24.3	51.5	19.9-j5.9	32.8	42.1	16.2	58.9
1930	50+j0.00	9.5-j12.2	31.5	43.9	24.8	53.0	18.8-j5.6	32.7	42.1	16.2	59.0
1995	50+j0.00	8.9-j12.6	31.3	44.0	25.1	52.3	15.1-j5.6	32.5	42.4	17.6	59.2
2110	50+j0.00	7.8-j12.8	31.0	44.1	25.9	51.7	10.2-j7.4	32.2	43.2	20.7	59.7
2200	50+j0.00	7.1-j11.9	31.2	44.2	26.0	52.8	8.4-j7.4	32.4	43.1	20.6	60.0

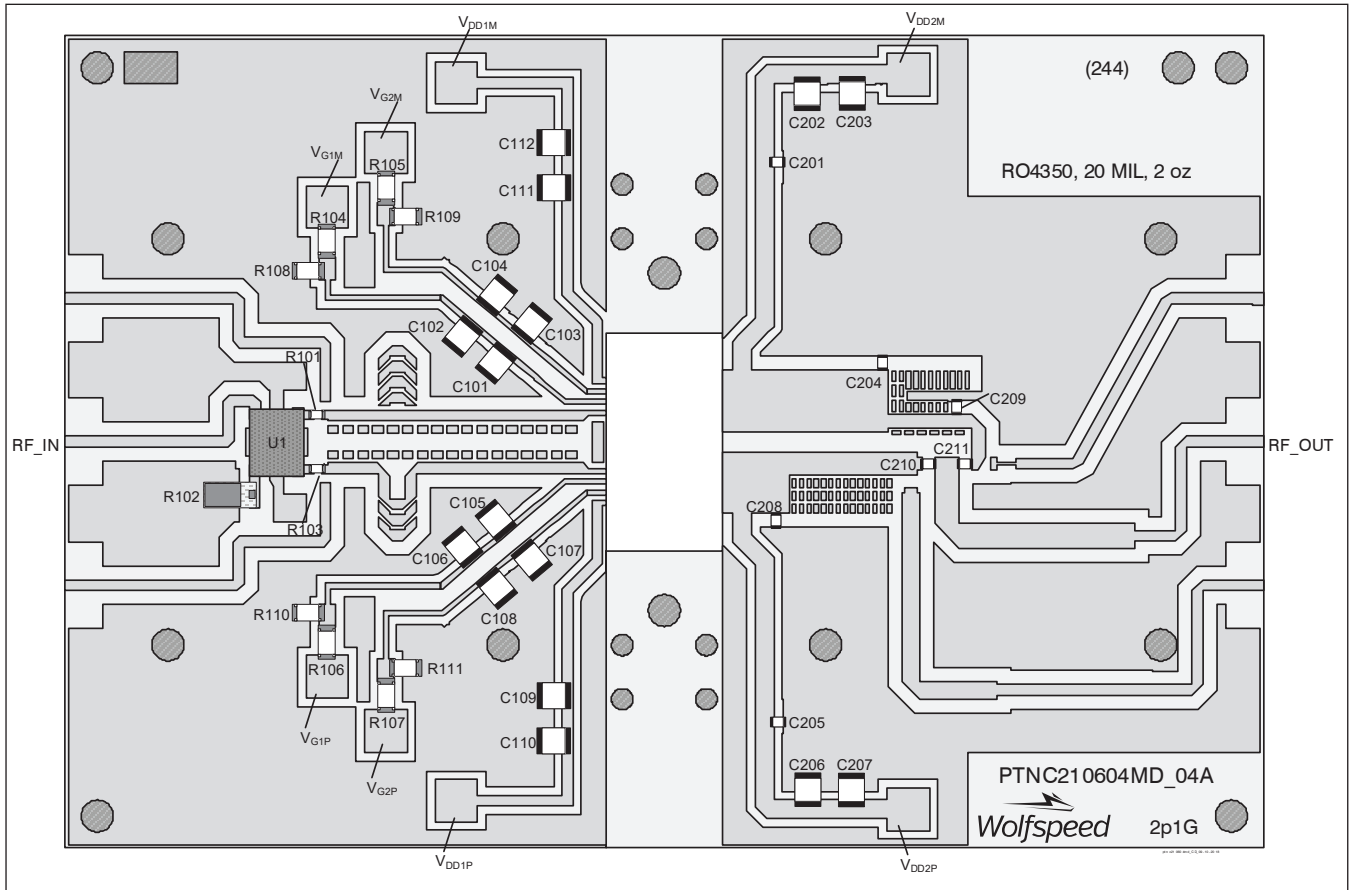
		P <sub>3dB</sub>									
		Max Output Power					Max PAE				
Freq [MHz]	Z <sub>s</sub> [W]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>3dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>3dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]
1805	50+j0.00	9.4-j13.6	29.4	44.8	29.9	53.0	20.1-j12.4	30.7	43.3	21.6	60.2
1880	50+j0.00	9.2-j12.3	29.5	44.7	29.5	52.8	18.4-j8.9	30.7	43.3	21.4	60.1
1930	50+j0.00	8.8-j13.3	29.3	44.8	30.2	52.5	16.1-j7.4	30.6	43.4	22.0	59.9
1995	50+j0.00	8.5-j13.5	29.1	44.8	30.3	52.0	13.9-j6.1	30.5	43.4	21.7	59.9
2110	50+j0.00	7.6-j13.2	28.9	44.9	30.9	51.6	10.2-j6.5	30.3	43.6	22.8	59.5
2200	50+j0.00	6.9-j12.6	29.0	44.9	30.8	51.7	7.9-j6.5	30.5	43.4	22.1	59.5

Peak Side Load Pull Performance – Pulsed CW signal: 1 ms, 10% duty cycle, 28 V, I<sub>DQ</sub> = 40 mA, V<sub>GS2P</sub> = 2.6 V

		P <sub>1dB</sub>									
		Max Output Power					Max PAE				
Freq [MHz]	Z <sub>s</sub> [W]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>1dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>1dB</sub> [dBm]	P <sub>1dB</sub> [W]	PAE [%]
1805	50+j0.00	3.4-j10.1	26.3	47.7	58.5	52.5	6.2-j8.4	26.9	46.6	45.7	62.0
1880	50+j0.00	3.2-j10.5	26.3	47.6	58.1	51.7	5.2-j8.1	26.9	46.4	43.9	60.6
1930	50+j0.00	3.0-j10.7	26.2	47.6	57.5	50.7	5.0-j8.6	26.8	46.5	44.5	60.0
1995	50+j0.00	3.1-j10.9	26.4	47.5	56.8	51.6	4.8-j8.5	26.8	46.3	42.6	59.0
2110	50+j0.00	2.6-j10.3	26.4	47.5	56.4	50.3	3.2-j8.4	27.0	46.4	43.5	58.6
2200	50+j0.00	2.5-j10.0	26.4	47.4	54.5	52.0	2.7-j8.4	26.9	46.3	43.0	59.2

		P <sub>3dB</sub>									
		Max Output Power					Max PAE				
Freq [MHz]	Z <sub>s</sub> [W]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>3dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]	Z <sub>L</sub> [W]	Gain [dB]	P <sub>3dB</sub> [dBm]	P <sub>3dB</sub> [W]	PAE [%]
1805	50+j0.00	3.5-j10.2	24.3	48.2	66.6	52.4	6.2-j8.3	24.9	47.2	52.3	60.4
1880	50+j0.00	3.3-j10.6	24.3	48.2	65.7	51.2	5.2-j8.5	24.9	47.2	52.1	58.9
1930	50+j0.00	3.0-j11.0	24.1	48.1	64.8	49.3	4.8-j8.6	24.8	47.2	52.0	57.9
1995	50+j0.00	2.9-j10.9	24.3	48.1	64.1	49.3	4.7-j8.8	24.8	47.1	50.8	56.5
2110	50+j0.00	2.7-j10.4	24.4	48.0	63.1	49.8	3.3-j8.6	25.0	47.1	51.7	56.4
2200	50+j0.00	2.5-j10.1	24.3	47.8	60.5	51.3	2.7-j8.6	24.9	47.0	50.2	57.1

Reference Circuit, 2100 – 2200 MHz



Reference circuit assembly diagram (not to scale)

Reference Circuit Assembly

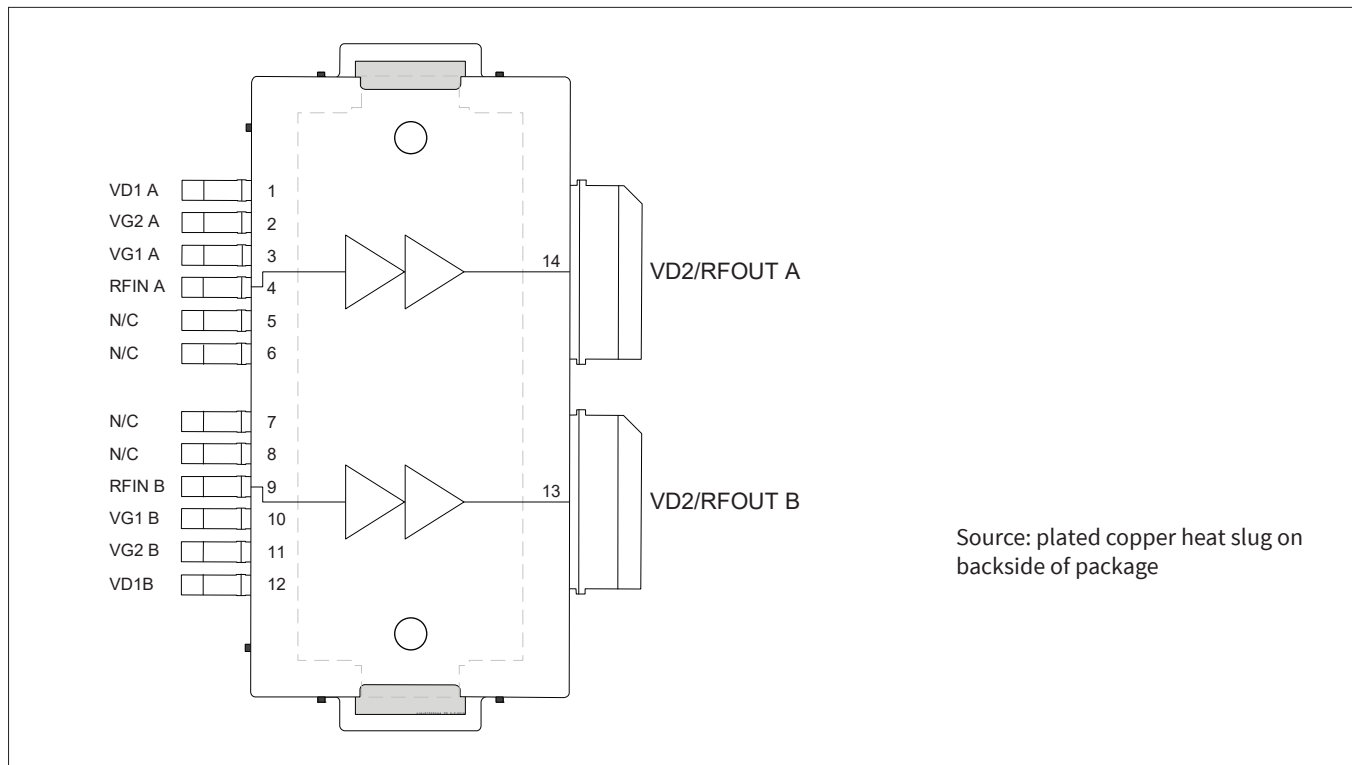
DUT	PTNC210604MD-V1
Test Fixture Part No.	LTN/PTNC210604MD-V1
PCB	Rogers 4350, 0.508 mm [0.020"] thick, 2 oz. copper, $\epsilon_r = 3.66$ , $f = 2100 - 2200$ MHz
Find Gerber files for this test fixture on the Wolfspeed Web site at <a href="http://www.wolfspeed.com/RF">www.wolfspeed.com/RF</a>	

Reference Circuit, 2100 – 2200 MHz (cont.)

Components Information

Component	Description	Manufacturer	P/N
C101, C103, C105, C107, C109, C111, C202, C206	Capacitor, 4.7 $\mu$ F	Murata Electronics North America	GRM32ER71H475KA88L
C102, C104, C106, C108, C110, C112, C203, C207	Capacitor, 10 $\mu$ F	Taiyo Yuden	UMK325C7106MM-T
C201, C205	Capacitor, 10 pF	ATC	ATC800A100JT250T
C204	Capacitor, 1.8 pF	ATC	ATC600F1R8BT250XT
C208	Capacitor, 2.0 pF	ATC	ATC600F2R0BT250XT
C209	Capacitor, 2.7 pF	ATC	ATC600F2R7BT250XT
C210, C211	Capacitor, 8.2 pF	ATC	ATC600F8R2BT250XT
R101, R103	Resistor, 0 ohms	Panasonic Electronic Components	ERJ-3GEY0R00V
R102	Resistor, 50 ohms	Anaren	C16A50Z4
R104, R105, R106, R107	Resistor, 1K ohms	Panasonic Electronic Components	ERJ-8GEYJ102V
R108, R109, R110, R111	Resistor, 4.3K ohms	Panasonic Electronic Components	ERJ-8GEYJ432V
U1	Hybrid Coupler	Anaren	X3C21P1-04S

Pinout Diagram (top view)



Source: plated copper heat slug on backside of package

Lead connections for PTNC210604MD

Package Outline Specifications

Package PG-HB1DSO-14-1 (top view)

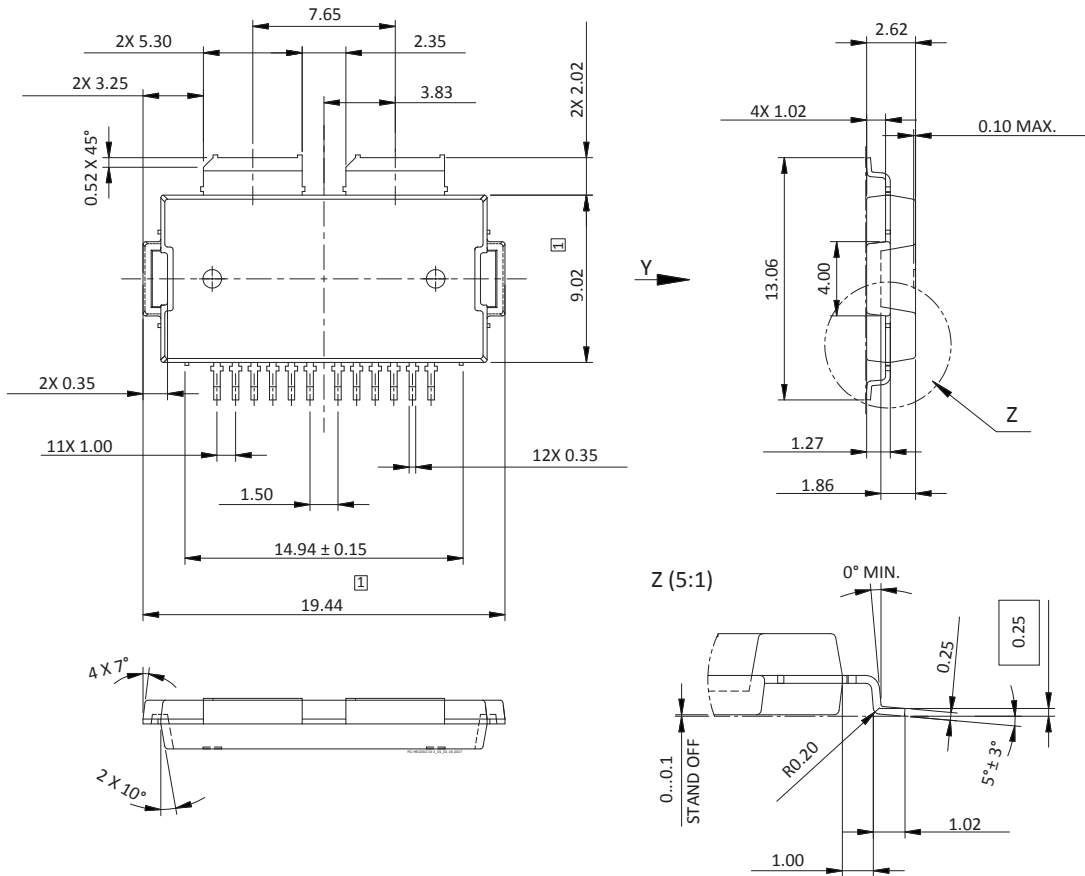


Diagram Notes—unless otherwise specified:

1. Mold/dam bar/metal protrusion of 0.30 mm max per side not included.
2. Metal protrusions are connected to source and shall not exceed 0.10 mm max.
3. Fillets and radii: all radii are 0.30 mm max.
4. Interpret dimensions and tolerances per ISO 8015.
5. Dimensions are mm.
6. All tolerances ± 0.1 mm unless specified otherwise.
7. All metal surfaces pre-plated, except area of cut.
8. Lead thickness: 0.25 mm.
9. Gold plating thickness: 0.25 micron max.



## Package Outline Specifications

Package PG-HB1DSO-14-1 (bottom view)

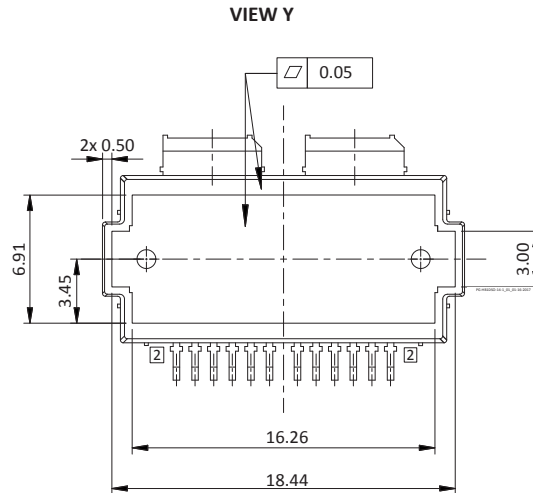


Diagram Notes—unless otherwise specified:

1. Mold/dam bar/metal protrusion of 0.30 mm max per side not included.
2. Metal protrusions are connected to source and shall not exceed 0.10 mm max.
3. Fillets and radii: all radii are 0.30 mm max.
4. Interpret dimensions and tolerances per ISO 8015.
5. Dimensions are mm.
6. All tolerances  $\pm 0.1$  mm unless specified otherwise.
7. All metal surfaces pre-plated, except area of cut.
8. Lead thickness: 0.25 mm.
9. Gold plating thickness: 0.25 micron max.

## Revision History

Revision	Date	Data Sheet Type	Page	Subjects (major changes since last revision)
01	2017-12-05	Advance	All	Data Sheet reflects advance specification for product development
02	2018-05-17	Advance	All	Updated single-carrier specs, DC characteristics, converted to Wolfspeed Data Sheet
03	2018-09-06	Production	All	Data Sheet reflects released product specification
03.1	2018-11-08	Production	6	Corrected test fixture part no.

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## Notes

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